

November 2013

FQD7P20

P-Channel QFET® MOSFET

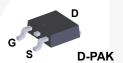
-200 V, -5.7 A, 690 mΩ

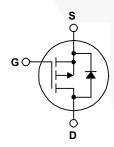
Description

This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance • Low Crss (Typ. 25 pF) and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, • 100% Avalanche Tested DC motor control, and variable switching power applications.

Features

- -5.7 A, -200 V, $R_{DS(on)}$ = 690 m Ω (Max.) @ V_{GS} = -10 V, $I_D = -2.85 A$
- Low Gate Charge (Typ. 19 nC)





Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | Parameter | /- | FQD7P20TM | Unit |
|-----------------------------------|---|----------|-------------|------|
| V_{DSS} | Drain-Source Voltage | | -200 | V |
| I _D | Drain Current - Continuous (T _C = 25°C) | | -5.7 | Α |
| | - Continuous (T _C = 100°C) | | -3.6 | Α |
| I _{DM} | Drain Current - Pulsed | (Note 1) | -22.8 | Α |
| V _{GSS} | Gate-Source Voltage | | ± 30 | V |
| E _{AS} | Single Pulsed Avalanche Energy | (Note 2) | 570 | mJ |
| I _{AR} | Avalanche Current | (Note 1) | -5.7 | Α |
| E _{AR} | Repetitive Avalanche Energy | (Note 1) | 5.5 | mJ |
| dv/dt | Peak Diode Recovery dv/dt (Note 3) | | -5.5 | V/ns |
| P_{D} | Power Dissipation (T _A = 25°C) * | | 2.5 | W |
| | Power Dissipation (T _C = 25°C) | | 55 | W |
| | - Derate above 25°C | | 0.44 | W/°C |
| T _J , T _{STG} | Operating and Storage Temperature Range | | -55 to +150 | °C |
| T _L | Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds. | | 300 | °C |

Thermal Characteristics

| Symbol | Parameter | FQD7P20TM | Unit |
|-----------------|---|-----------|------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case, Max. | 2.27 | |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max. | 110 | °C/W |
| | Thermal Resistance, Junction to Ambient (*1 in ² Pad of 2-oz Copper), Max. | 50 | |

Package Marking and Ordering Information

| Part Number | Top Mark | Package | Packing Method | Reel Size | Tape Width | Quantity |
|-------------|----------|---------|----------------|-----------|------------|------------|
| FQD7P20TM | FQD7P20 | D-PAK | Tape and Reel | 330 mm | 16 mm | 2500 units |

Flectrical Characteristics

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Unit |
|---------------------|---|--|------|------|-------|------|
| Off Cha | aracteristics | | | | | |
| BV _{DSS} | Drain-Source Breakdown Voltage | $V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$ | -200 | | | V |
| ΔBV _{DSS} | Breakdown Voltage Temperature Coefficient | I _D = -250 μA, Referenced to 25°C | | -0.1 | | V/°C |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = -200 V, V _{GS} = 0 V | | | -1 | μΑ |
| | | V _{DS} = -160 V, T _C = 125°C | | | -10 | μΑ |
| I _{GSSF} | Gate-Body Leakage Current, Forward | V _{GS} = -30 V, V _{DS} = 0 V | | | -100 | nA |
| I _{GSSR} | Gate-Body Leakage Current, Reverse | V _{GS} = 30 V, V _{DS} = 0 V | | | 100 | nA |
| On Cha | aracteristics | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} = V _{GS} , I _D = -250 μA | -3.0 | | -5.0 | V |
| R _{DS(on)} | Static Drain-Source On-Resistance | V _{GS} = -10 V, I _D = -2.85 A | | 0.54 | 0.69 | Ω |
| 9 _{FS} | Forward Transconductance | V _{DS} = -40 V, I _D = -2.85 A | | 3.7 | | S |
| Dynam | ic Characteristics | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ | | 590 | 770 | pF |
| C _{oss} | Output Capacitance | f = 1.0 MHz | | 140 | 180 | pF |
| C _{rss} | Reverse Transfer Capacitance | | | 25 | 35 | pF |
| Switchi | ing Characteristics | | | | | |
| t _{d(on)} | Turn-On Delay Time | V _{DD} = -100 V, I _D = -7.3 A, | | 15 | 40 | ns |
| t _r | Turn-On Rise Time | $R_{G} = 25 \Omega$ | | 110 | 230 | ns |
| t _{d(off)} | Turn-Off Delay Time | 11G - 20 32 | | 30 | 70 | ns |
| t _f | Turn-Off Fall Time | (Note 4) | | 42 | 90 | ns |
| Qg | Total Gate Charge | $V_{DS} = -160 \text{ V}, I_{D} = -7.3 \text{ A},$ | | 19 | 25 | nC |
| Q _{gs} | Gate-Source Charge | V _{GS} = -10 V | | 4.6 | | nC |
| Q _{gd} | Gate-Drain Charge | (Note 4) | / | 9.5 | | nC |
| Drain-S | Source Diode Characteristics a | nd Maximum Ratings | 7 | | | |
| I _S | Maximum Continuous Drain-Source Diode Forward Current | | | | -5.7 | Α |
| I _{SM} | Maximum Pulsed Drain-Source Diode Forward Current | | | | -22.8 | Α |
| V _{SD} | Drain-Source Diode Forward Voltage | V _{GS} = 0 V, I _S = -5.7 A | | | -5.0 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} = 0 V, I _S = -7.3 A, | | 180 | | ns |
| | Reverse Recovery Charge dl _F / dt = 100 A/μs | | | | 1 | |

- Notes. 1. Repetitive rating: pulse-width limited by maximum junction temperature. 2. L = 26.3 mH, I_{AS} = -5.7 A, V_{DD} = -50 V, R_{G} = 25 Ω , starting T_{J} = 25°C. 3. $I_{SD} \le$ -7.3 A, di/dt \le 300 A/µs, $V_{DD} \le$ BV_{DSS}, starting T_{J} = 25°C. 4. Essentially independent of operating temperature.

Typical Characteristics

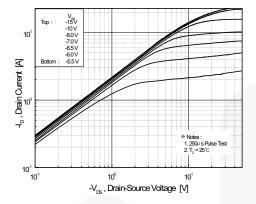


Figure 1. On-Region Characteristics

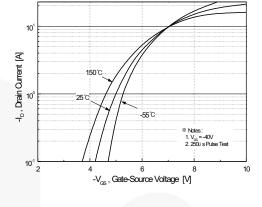


Figure 2. Transfer Characteristics

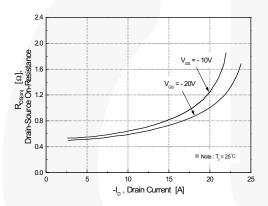


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

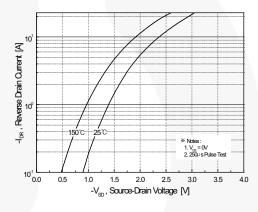


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

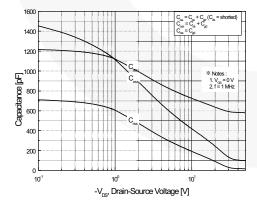


Figure 5. Capacitance Characteristics

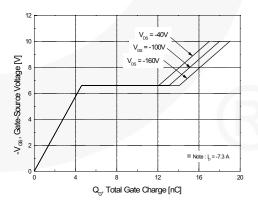


Figure 6. Gate Charge Characteristics

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Typical Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

T,, Junction Temperature [°C]

150

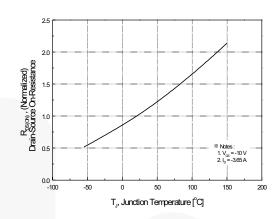


Figure 8. On-Resistance Variation vs. Temperature

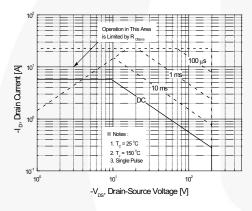


Figure 9. Maximum Safe Operating Area

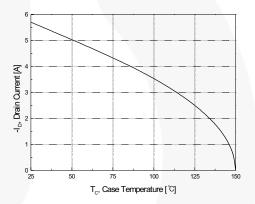


Figure 10. Maximum Drain Current vs. Case Temperature

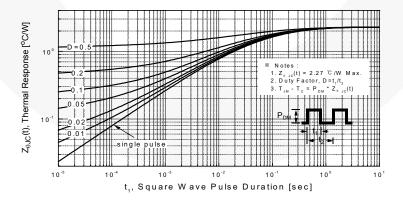


Figure 11. Transient Thermal Response Curve

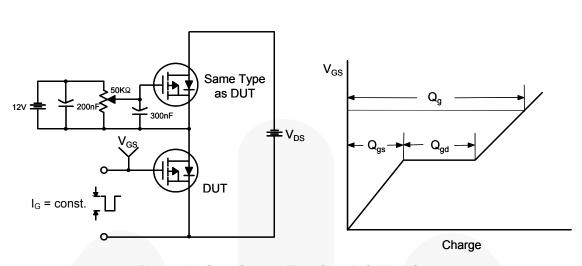


Figure 12. Gate Charge Test Circuit & Waveform

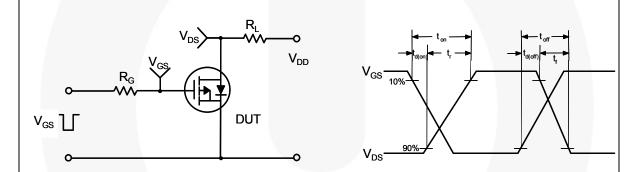


Figure 13. Resistive Switching Test Circuit & Waveforms

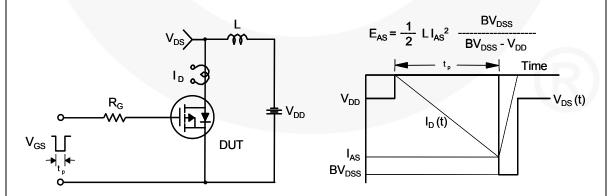
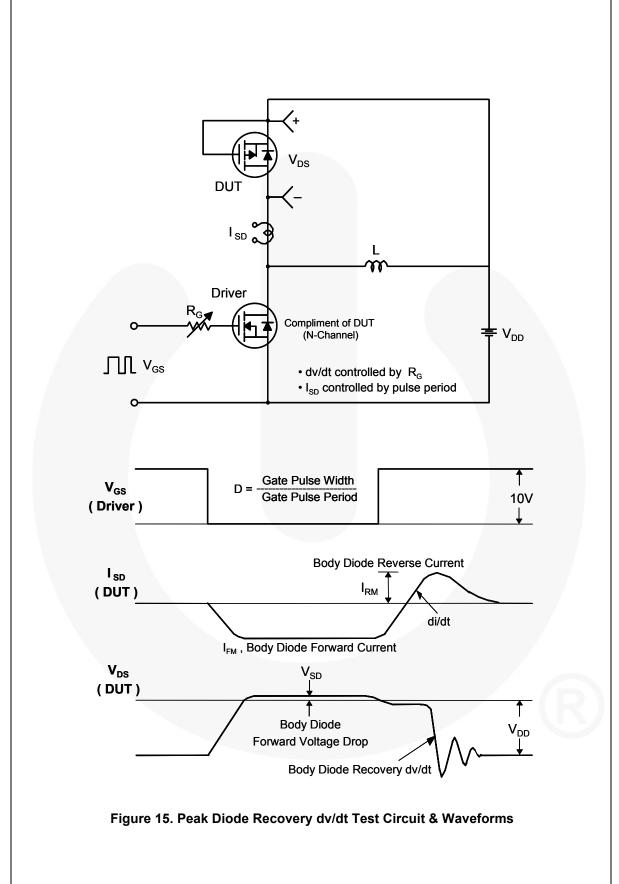


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



Mechanical Dimensions

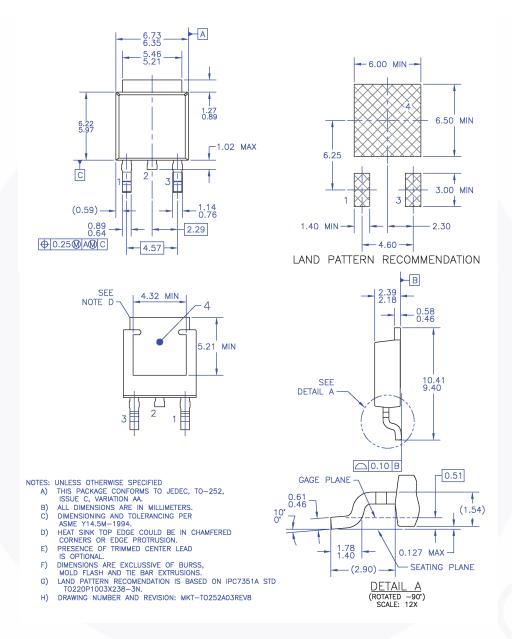


Figure 16. TO252 (D-PAK), Molded, 3-Lead, Option AA&AB

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